Docket No.: 67162-021 PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 20277

Ryu MAKABE, et al. : Confirmation Number:

Serial No.: : Group Art Unit:

Filed: September 16, 2003 : Examiner: Unknown

For: SEMICONDUCTOR WAFER, SEMICONDUCTOR CHIP AND DICING METHOD OF

A SEMICONDUCTOR WAFER

## INFORMATION DISCLOSURE STATEMENT

Mail Stop IDS Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the documents listed on the attached form PTO-1449. It is respectfully requested that the documents be expressly considered during the prosecution of this application, and that the documents be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

This Information Disclosure Statement is being filed within three months of the U.S. filing date OR before the mailing date of a first Office Action on the merits. No certification or fee is required.

## Serial No.:

Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account 500417 and please credit any excess fees to such deposit account.

Respectfully submitted,

MCDERMOTT, WILL & EMERY

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Date: September 16, 2003

INFORMATION DISCLOSURE CITATION IN AN APPLICATION					ATTY. DOCKET NO. 67162-021	SE	SERIAL NO.		
					APPLICANT Ryu MAKABE, et	APPLICANT Ryu MAKABE, et al.			
(PTO-1449)					FILING DATE September 16, 20	FILING DATE GROUP September 16, 2003			
				U.S. PATE	NT DOCUMENTS	<u> </u>			
EXAMINER'S INITIALS	CITE NO.	Document Number Number-Kind Code2 (# known)		Publication Da MM-DD-YYY		Name of Patentee or Applicant of Cited Document		Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	
		US	5,982,042	11/09/1999	Nakamura		Corresponding to JP 9-25	52034	
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EXAMINER'S		Foreign Patent Document		Publication Date		Pages,	Translation	Translation	
INITIALS	CITE NO.	Country Codes -Number 4 -Kind Codes (if known)		MM-DD-YYYY	Applicant of Cited Document		ant		
							Yes	No	
			JP 9-252034	09/22/1997	MITSUBISHI ELECTRIC CORP (JP)		(Japan w/English Abstract)		
	A		JP P2001-60567	03/06/2001	SEIKO EPSON CORP		(Japan w/English Abstract)		
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		<u> </u>	OTHER A	I IRT (Including Aut	<u> </u>	Etc.)			
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1 Applicant's unique citation designation number (optional). 2 Applicant is to place a check mark here if English language Translation is attached.